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Jc# 625 U.S. UTILITY Patent Application

O.I.P.E. PATENT DATE

NAY 1 3 2003

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TERMINAL		DRAWINGS		CLAIMS ALLOWED			
DISCLAIMER	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.		
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The term of this patent shall not extend beyond the expiration date of U.S Patent. No.	George Nguyen Primary Examinar			12-11-07 ISSUE FEE AH			
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